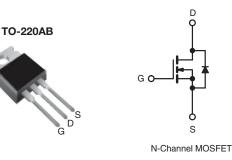


Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|-----------------------|--|--|--|--|
| V _{DS} (V) | 100 | | | | |
| R _{DS(on)} (Ω) | $V_{GS} = 5.0 V$ 0.16 | | | | |
| Q _g (Max.) (nC) | 28 | | | | |
| Q _{gs} (nC) | 3.8 | | | | |
| Q _{gd} (nC) | 14 | | | | |
| Configuration | Single | | | | |



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$ Specified at $V_{GS} = 4 V$ and 5 V
- 175 °C Operating Temperature
- · Fast Switching
- Ease of Paralleling
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

| ORDERING INFORMATION | | | | |
|----------------------|------------|--|--|--|
| Package | TO-220AB | | | |
| Lead (Pb)-free | IRL530PbF | | | |
| Lead (FD)-liee | SiHL530-E3 | | | |
| SnPb | IRL530 | | | |
| | SiHL530 | | | |

| ABSOLUTE MAXIMUM RATINGS (T _C | = 25 °C, unl | ess otherwis | se noted) | | | |
|---|--|------------------------|-----------------------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V _{DS} | 100 | V | |
| Gate-Source Voltage | | | V _{GS} | ± 10 | V | |
| Continuous Drain Current | V_{GS} at 5.0 V $\frac{T_C = 25 \degree C}{T_C = 100 \degree C}$ | | 15 | | | |
| | V _{GS} at 5.0 V | $T_C = 100 \ ^\circ C$ | I _D | 11 | А | |
| Pulsed Drain Current ^a | | | I _{DM} | 60 | | |
| Linear Derating Factor | | | | 0.59 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 290 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 15 | А | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 8.8 | mJ | |
| Maximum Power Dissipation $T_{C} = 25 \text{ °C}$ | | | PD | 88 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 5.5 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 175 | °C | |
| Soldering Recommendations (Peak Temperature) | for | 10 s | | 300 ^d | | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in | |
| | | | | 1.1 | N · m | |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = 25 V, starting T_J = 25 °C, L = 1.9 mH, R_g = 25 Ω I_{AS} = 15 A (see fig. 12).

c. $I_{SD} \le 15$ A, dI/dt ≤ 140 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 175$ °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

Document Number: 91299 S11-0518-Rev. B, 21-Mar-11 www.vishay.com

IRL530, SiHL530

Vishay Siliconix



| THERMAL RESISTANCE RATINGS | | | | | | | | |
|--|-----------------------|---|------------------------------------|------------------------------------|------------|-----------|-----------------------|------------------|
| PARAMETER | SYMBOL | TYP. | | MAX. | | UNIT | | |
| Maximum Junction-to-Ambient | R _{thJA} | - | | 62 | | | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.50 | 0.50 - | | | °C/W | | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - 1.7 | | | | | | |
| | | | | | | | | |
| SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, | unless otherv | vise noted) | | | | | | |
| PARAMETER | SYMBOL | TEST | CONDITI | ONS | MIN. | TYP. | MAX. | UNIT |
| Static | | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0$ | V, I _D = 2 | 50 µA | 100 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference t | o 25 °C, I | _D = 1 mA | - | 0.14 | - | V/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | $V_{DS} = V_0$ | _{GS} , I _D = 2 | 50 µA | 1.0 | - | 2.0 | V |
| Gate-Source Leakage | I _{GSS} | Vo | $as = \pm 10$ | | - | - | ± 100 | nA |
| Zene Oete Maltere Drein Ormert | | V _{DS} = 10 | 00 V, V _{GS} | = 0 V | - | - | 25 | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 80 V, V ₀ | _{GS} = 0 V, 1 | T _J = 150 °C | - | - | 250 | μA |
| | _ | V _{GS} = 5.0 V | ١ _D | = 9.0 A ^b | - | - | 0.16 | _ |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 4.0 V | ۱ _D | = 7.5 A ^b | - | - | 0.22 | Ω |
| Forward Transconductance | g fs | V _{DS} = 50 | 0 V, I _D = 9 | 9.0 A ^b | 6.4 | - | - | S |
| Dynamic | I | | | | 1 | | I | 1 |
| Input Capacitance | C _{iss} | $V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5 | | - | 930 | - | pF | |
| Output Capacitance | C _{oss} | | | - | 250 | - | | |
| Reverse Transfer Capacitance | C _{rss} | | | - | 57 | - | | |
| Total Gate Charge | Qg | | | | - | - | 28 | |
| Gate-Source Charge | Q _{gs} | $V_{GS} = 5.0 \text{ V} \qquad \begin{array}{c} I_D = 15 \text{ A}, V_{DS} = 80 \text{ V},\\ \text{see fig. 6 and } 13^{\text{b}} \end{array} .$ | | | - | - | 3.8 | nC |
| Gate-Drain Charge | Q _{gd} | | | - | - | 14 | 1 | |
| Turn-On Delay Time | t _{d(on)} | | | | - | 4.7 | - | - |
| Rise Time | t _r | - | | | - | 100 | - | |
| Turn-Off Delay Time | t _{d(off)} | $V_{DD} = 50 \text{ V}, I_D = 15 \text{ A},$ $R_g = 12 \Omega, R_D = 32 \Omega, \text{ see fig. } 10^{\text{b}}$ | | - | 22 | - | ns | |
| Fall Time | t _f | 1 | | | - | 48 | - | 1 |
| Internal Drain Inductance | L _D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 4.5 | - | | |
| Internal Source Inductance | L _S | | | - | 7.5 | - | nH | |
| Drain-Source Body Diode Characteristic | cs | • | | | • | 4 | | ļ |
| Continuous Source-Drain Diode Current | ١ _S | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 15 | A | |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 60 | | |
| Body Diode Voltage | V_{SD} | T _J = 25 °C, I ₅ | _s = 15 A, | V _{GS} = 0 V ^b | - | - | 2.5 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T 25 °C L - | 15 A di/a | | - | 150 | 200 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | - $T_J = 25 \text{ °C}, I_F = 15 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}^b$ | | - | 0.93 | 1.4 | μC | |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn | | | -on is doi | minated b | by L _S and | L _D) |

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$

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IRL530, SiHL530

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

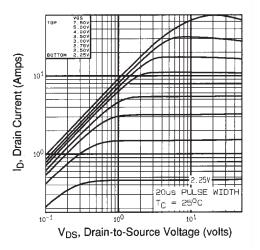


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

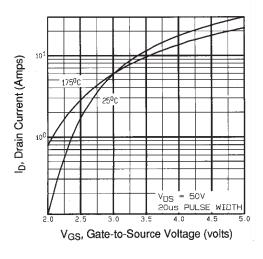


Fig. 3 - Typical Transfer Characteristics

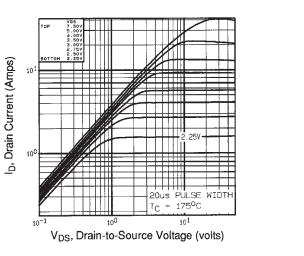


Fig. 2 - Typical Output Characteristics, T_C = 175 °C

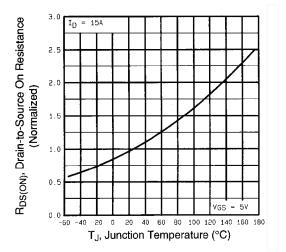


Fig. 4 - Normalized On-Resistance vs. Temperature

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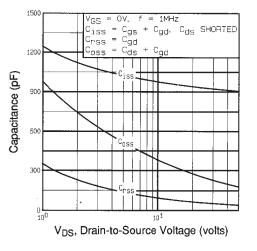


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

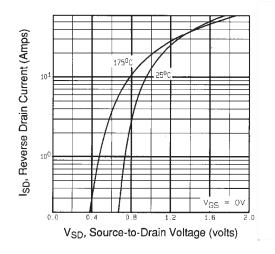


Fig. 7 - Typical Source-Drain Diode Forward Voltage

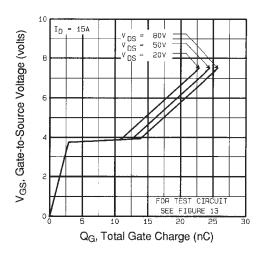


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

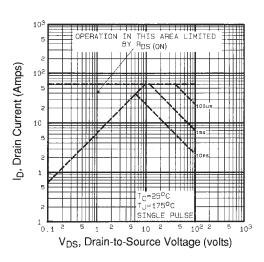


Fig. 8 - Maximum Safe Operating Area

Document Number: 91299 S11-0518-Rev. B, 21-Mar-11



IRL530, SiHL530

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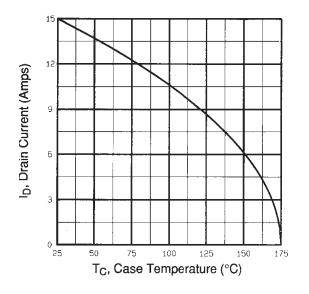


Fig. 9 - Maximum Drain Current vs. Case Temperature

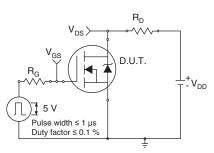


Fig. 10a - Switching Time Test Circuit

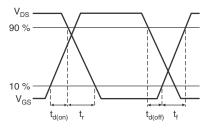


Fig. 10b - Switching Time Waveforms

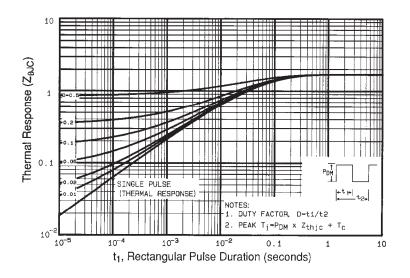


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



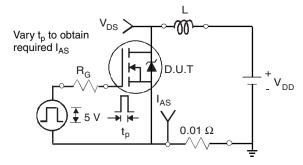


Fig. 12a - Unclamped Inductive Test Circuit

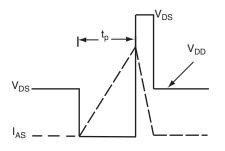


Fig. 12b - Unclamped Inductive Waveforms

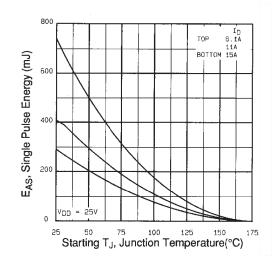


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

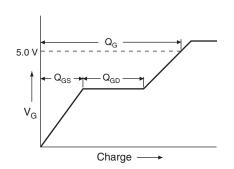


Fig. 13a - Basic Gate Charge Waveform

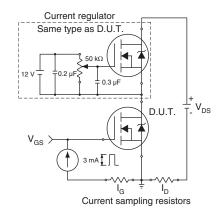
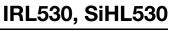


Fig. 13b - Gate Charge Test Circuit

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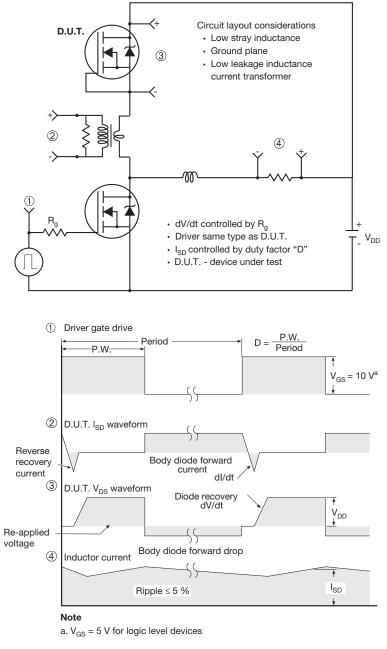


Fig. 14 - For N-Channel

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TO-220-1



| DIM. | MILLIN | IETERS | INCHES | | |
|--|--------|--------|--------|-------|--|
| DIN. | MIN. | MAX. | MIN. | MAX. | |
| А | 4.24 | 4.65 | 0.167 | 0.183 | |
| b | 0.69 | 1.02 | 0.027 | 0.040 | |
| b(1) | 1.14 | 1.78 | 0.045 | 0.070 | |
| С | 0.36 | 0.61 | 0.014 | 0.024 | |
| D | 14.33 | 15.85 | 0.564 | 0.624 | |
| E | 9.96 | 10.52 | 0.392 | 0.414 | |
| е | 2.41 | 2.67 | 0.095 | 0.105 | |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 | |
| F | 1.14 | 1.40 | 0.045 | 0.055 | |
| H(1) | 6.10 | 6.71 | 0.240 | 0.264 | |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 | |
| L | 13.36 | 14.40 | 0.526 | 0.567 | |
| L(1) | 3.33 | 4.04 | 0.131 | 0.159 | |
| ØР | 3.53 | 3.94 | 0.139 | 0.155 | |
| Q | 2.54 | 3.00 | 0.100 | 0.118 | |
| ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031 | | | | | |

Note

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

| Package Picture | | | | | | |
|-----------------|--|---------------------|--|--|--|--|
| ASE | | Xi'an | | | | |
| | | IRF 9510 744K AB | | | | |

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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